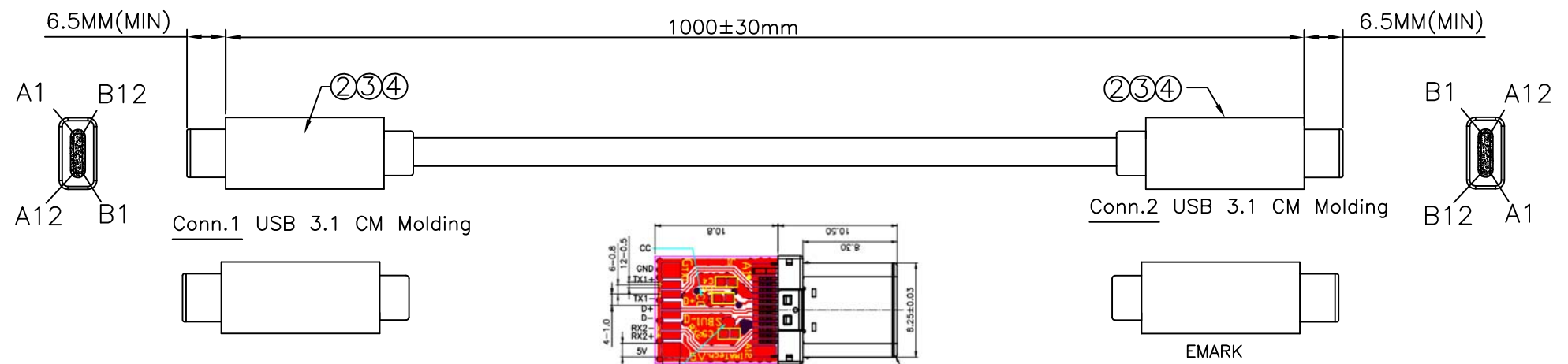


REV	ECN.NO:	BY	DATE
A01	NEW DWG	Star Chen	16.08.11



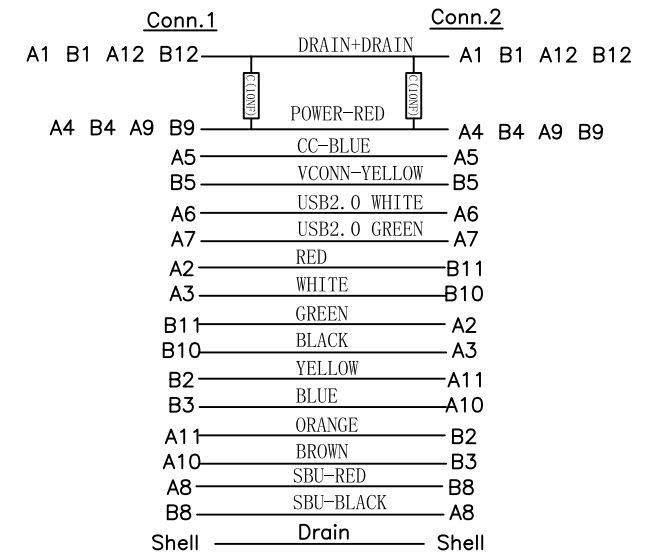
Electrical Test:

1. 100%Test(Open, short ,miss wire)
2. Contact Resistance: 2 ohm max.
3. Insulation Resistance: 5M ohm min.
4. Hi-pot:300V DC/10ms

NOTE:

1. Super High Speed USB 3.1 Cable (30AWG*1P+D+AL+MY)*4C+30AWG*1P+30AWG*4C +22AWGT*2C+F+AB OD:5.0±0.2mm Color: Black
- 2.USB3.1 (C) M Solder Type Shell Nickel, Black Insulation,With USB3.1 C EMARK, PCB+SMT
- 3.INSIDE MOLDING:PE
- 4.OUTSIDE MOLDING:Black PVC
- 5.aluminum shell

Pin Assignment



COPLIANCE WITH THE REQUIEMENT RoHS HF SONY00259 OTHER
 ※ NO USING RESTRICTED AND BANNED SUBSTANCE

CUSTOMER DRAWING		LITE Liteconn Co.,Ltd.	
-TOLERANCES- UNLESS OTHERWISE SPECIFIED		TITLE: USB3.1 C TO C	
X.X ±0.35	X.X* ±3'	APPD:	DWG NO:
X.XX ±0.25	X.XX* ±2'	CHECK:	DATE
X.XXX ±0.15	X.XXX* ±1'	DRAW: Star Chen	2016.08.11
			SCALE
			UNIT
			PAGE
			1/1